## UM10482

# SSL21081 LED driver reference board Rev. 2.1 — 11 January 2012

User manual

## **Document information**

| Info     | Content  |
|----------|--|
| Keywords | SSL21081, buck converter, reference board, LED driver, LED retrofit lamp, low power  |
| Abstract | This document describes the performance, technical data and connection of the SSL21081 reference board. The SSL2108X series is an NXP Semiconductors driver IC intended to provide a low cost, small form factor LED driver. This board is intended to operate at 100 V (AC) or 120 V (AC), using an output voltage greater than 30 V. |



## SSL21081 LED driver reference board

## **Revision history**

| Rev          | Date     | Description                                     |
|--------------|----------|---|
| v.2.1        | 20120111 | fourth issue                                    |
| Modification | ns:      | • Figure 13 on page 14: 700 μH changed to 1 mH. |
| v.2          | 20111205 | third issue                                     |
| Modification | ns:      | Minor text modifications.                       |
| v.1.1        | 20110830 | second issue                                    |
| v.1          | 20110818 | first issue                                     |

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#### SSL21081 LED driver reference board

## 1. Introduction

## **WARNING**

#### Lethal voltage and fire ignition hazard





The non-insulated high voltages that are present when operating this product, constitute a risk of electric shock, personal injury, death and/or ignition of fire.

This product is intended for evaluation purposes only. It shall be operated in a designated test area by personnel qualified according to local requirements and labor laws to work with non-insulated mains voltages and high-voltage circuits. This product shall never be operated unattended.

The SSL21081 is a highly integrated switching mode LED driver which enables constant current driving from the AC mains input in a standard SO8 package. It is a solution for small LED retrofit lamp applications, especially those applications for low-power factor designs.

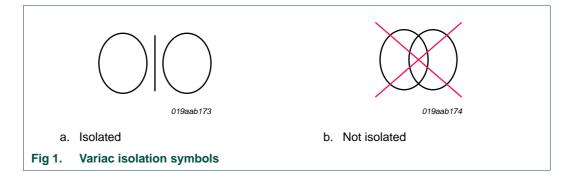
The SSL21081 supports buck converter topology and is suitable for non-isolated, non-dimmable LED retrofit lamps. It can drive a long LED string, up to a 70 V forward voltage and is most efficient in this type of LED module. The SSL2108 series is intended to operate at high output voltages.

This reference board is an example that can be used in applications up to E17 form factor lamp fittings.

Remark: Unless otherwise stated all voltages are in V (AC).

## 2. Safety warning

This reference board is connected to a high AC voltage. Avoid touching the reference board during operation. An isolated housing is mandatory when used in uncontrolled, non-laboratory environments. Galvanic isolation of the mains phase using a fixed or variable transformer (Variac) is always recommended. These devices are recognized by the symbols shown in Figure 1



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## 3. Connecting to the board

The reference board is optimized for a 100 V/60 Hz mains supply. In addition to the mains voltage optimization, the reference board is designed to operate with multiple LEDs or an LED module with a high forward voltage.

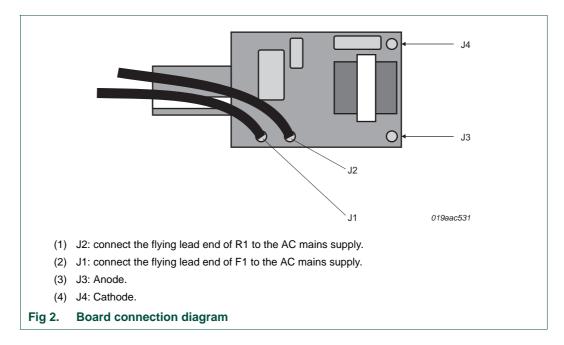
Mains connection of this reference board is different from other general evaluation/demo boards. Connect the mains to an axial lead resistor and fuse which are connected to J1 and J2. In the application, it is possible that one side of these components is directly connected to the socket.

**Remark:** The maximum rated voltage of the board is 141 V (limited by the value of electrolytic capacitor C1) or 200 V (DC).

Remark: The rated fuse voltage for F1 is 125 V.

An anode of the LED string is connected to J3 and a cathode is connected to J4. Use an LED string with a  $V_F$  greater than 20 V on this board. Under normal operating conditions, the output current is 100 mA. If the rated current of the LED string does not meet the specification, the LED output current is adjusted as described in Section 5.

The electrolytic capacitor is mounted outside the board so it can be mounted in the screw cap of the lamp. The temperature around screw cap is the lowest in the lamp. When the capacitor is placed in the screw cap, the life time of the electrolytic capacitor is improved.

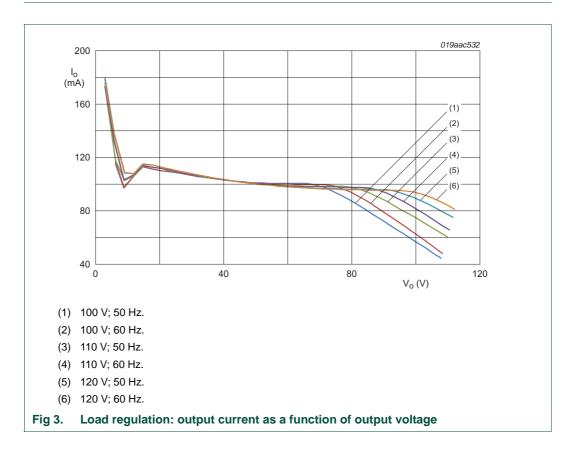


## SSL21081 LED driver reference board

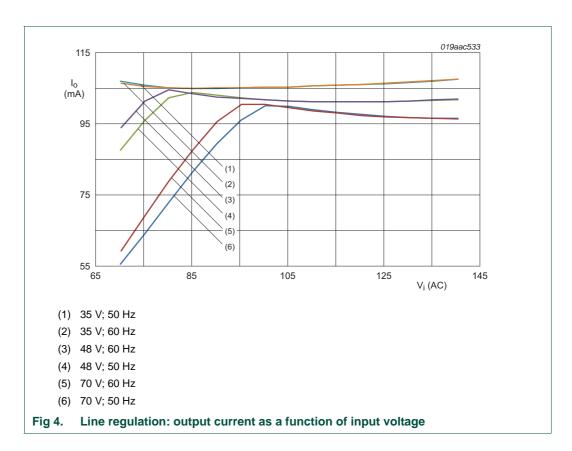
## 4. Specification

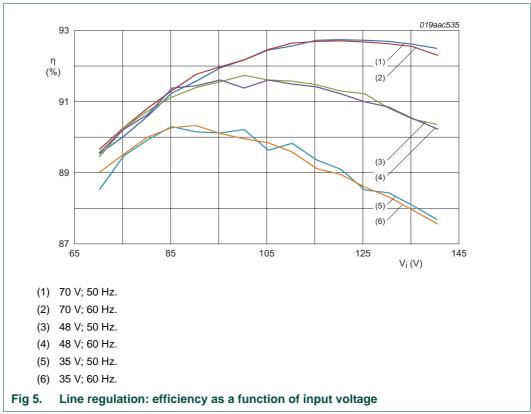
Table 1. Specifications for the reference board

| Parameter                                 | Value                 | Comment   |
|---|-----------------------|---|
| AC line input voltage                     | 85 V to 138 V         | the board is optimized for 100 V/60 Hz.                   |
| output voltage                            | > 20 V (DC)           | -   |
| output current                            | 100 mA                | at 100 V mains; 70 V LED                                  |
| output current dependency                 | ±5 %                  | 100 V ±10 % at 70 V; 100 mA output (see <u>Figure 4</u> ) |
| efficiency                                | > 90 %                | at 70 V; 100 mA output                                    |
| power factor                              | 0.6                   | at 70 V; 100 mA output                                    |
| board dimension (L $\times$ W $\times$ H) | 22 mm × 18 mm × 12 mm | -   |

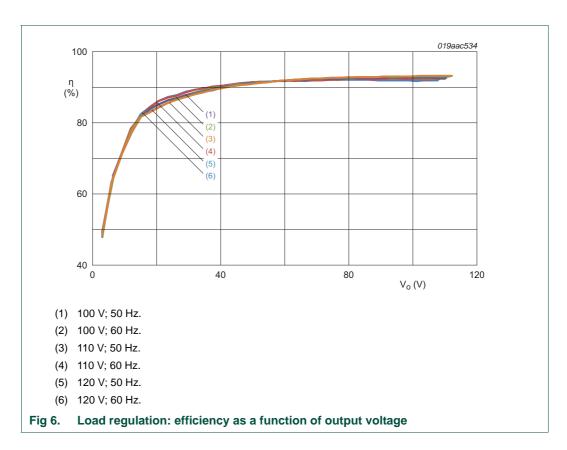


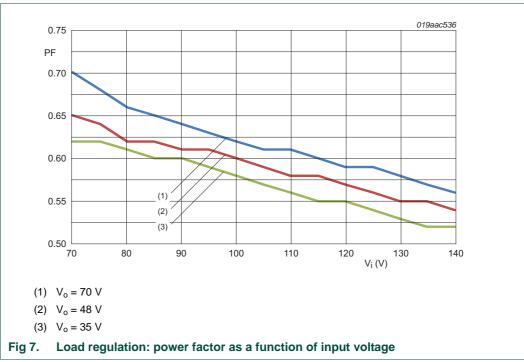
## SSL21081 LED driver reference board



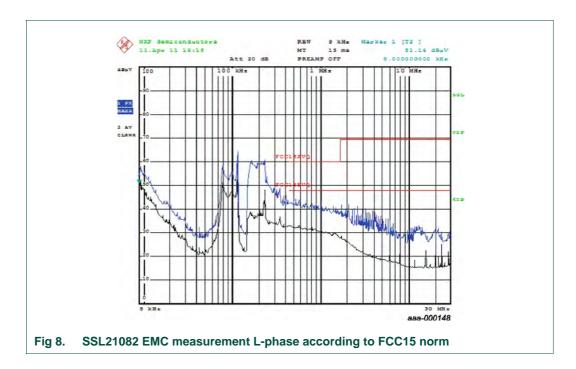


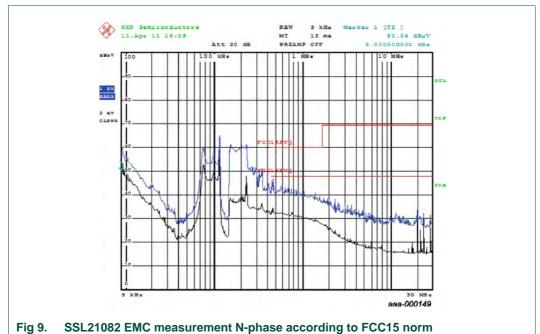
## SSL21081 LED driver reference board





## SSL21081 LED driver reference board





#### SSL21081 LED driver reference board

## 5. Changing the output current

The SSL21081 monitors the charging current in the inductor using the sense resistors R2A and R2B. It controls the internal MOSFET to ensure a constant peak current (I<sub>peak</sub>). In addition, the IC supports valley detection.

These features enable a driver to operate in Boundary Conduction Mode (BCM) with valley switching where the average current in the inductor is an output current.

The SSL21081 turns off the MOSFET when the voltage on pin SOURCE reaches 500 mV. If resistors R2A/R2B between pin SOURCE and GND are 2  $\Omega$ , the peak current is limited to 250 mA (see Equation 1).

$$I_{peak} = \frac{0.5 \times (R2A + R2B)}{R2A \times R2B} \tag{1}$$

When the MOSFET is switched off, inductor L2 is discharged and the current flowing through the inductor is decreased. When the current in the inductor reaches 0 mA, the voltage on pin DRAIN starts to oscillate. The SSL21081 waits for a valley in this oscillation. When the voltage on pin DRAIN reaches it lowest value, the MOSFET is turned on again.

The charge time of inductor L2 is calculated with Equation 2:

$$t_{ch} = L2 \times \frac{2 \times I_{LED}}{V_{IN} - V_{LED}} \tag{2}$$

The discharge time of inductor L2 is calculated using Equation 3:

$$t_{dch} = L2 \times \frac{2 \times I_{LED}}{V_{LED}} \tag{3}$$

When the inductor charges/discharges, a current flows through it. However, there is an effective current when oscillating. Consider the oscillation frequency when adjusting the output current. It can be calculated using Equation 4:

$$f_{ring} = \frac{1}{2 \times \pi \times \sqrt{L2 \times (C_{FFT} \pm C4)}} \tag{4}$$

The time from the start of oscillation to the first valley is calculated using Equation 5:

$$t_{ring} = \frac{1}{2 \times f_{ring}} \tag{5}$$

The output current is calculated using Equation 6:

$$I_{LED} = \frac{1}{2} \times I_{peak} \times \frac{t_{ch} + t_{dch}}{t_{ch} + t_{dch} + t_{ring}}$$

$$\tag{6}$$

#### SSL21081 LED driver reference board

## 6. External OverTemperature Protection (OTP)

The SSL21081 supports external OTP by adding an external Negative Temperature Coefficient (NTC) thermistor. This feature is delivered by detecting a voltage on pin NTC. The NTC pin has an integrated current source that generates an offset. The resistance of the NTC thermistor is decreased as the temperature increases. When the NTC temperature rises and the voltage on pin NTC falls to below 0.5 V, the SSL21081 lowers the threshold level for detecting peak current in the inductor. Decreasing the peak current in the inductor causes the power consumption in the system to decrease as well. The output current is adjusted to the point where a balance between safety temperature and output current can be retained (thermal management).

If the temperature on NTC increases continuously and the voltage on the pin drops below 0.3 V, the SSL21081 starts the NTC time-out timer. If the voltage on pin NTC pin does not drop below 0.2 V within the time-out, the SSL21081 detects an abnormal condition and stops switching.

An NTC thermistor can be directly connected to pin NTC. It is also possible to tune the protection temperature by adding resistor in parallel or in series with the NTC. One NTC and one resistor are installed on the reference board. The values of these components can be changed depending on the protection temperature requirement and component availability.

#### SSL21081 LED driver reference board

## 7. Power factor adjustment

The SSL21081 reference board is designed for a standard operation with a power factor of 0.6 at 100 V. This option offers the highest efficiency. There are two ways of tuning the power factor for higher values. The first option is by increasing the value of R1. A higher R1 value raises the power factor to above 0.7, resulting in additional losses (see <u>Table 2</u>).

| Table 2. | Power factor | adjustment - | increasing the | value of resistor R1 |
|----------|--------------|--------------|----------------|----------------------|
|----------|--------------|--------------|----------------|----------------------|

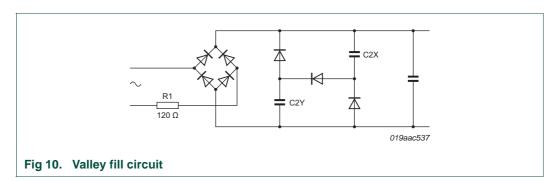
| V <sub>i</sub> (V) | V <sub>o</sub> (V <sub>avr</sub> ) | I <sub>o</sub> (mA) | R1 (Ω) | η (%) | Power factor | THD (%) |
|--------------------|------------------------------------|---------------------|--------|-------|--------------|---------|
| 100                | 62.8                               | 127                 | 10     | 91.5  | 0.6131       | 111     |
| 100                | 62.8                               | 127                 | 33     | 85.0  | 0.701        | 90.5    |
| 120                | 62.5                               | 123                 | 68     | 84.7  | 0.711        | 94.2    |
| 120                | 63.1                               | 124                 | 100    | 81.9  | 0.75         | 84.3    |
| 120                | 43.5                               | 129                 | 100    | 82.7  | 0.715        | 95.1    |

Increasing R1 also results in a lower inrush current enabling the board to be connected to leading-edge phase cut dimmers without damage to the dimmer or lamp (dimmer resistant). This adjustment is not intended for stable operation without flicker or a good dimming range, but is for safety only. Dimension the power rating of R1 to handle peak powers that occur using leading-edge dimmers. This power is between 2 W and 4 W. Alternatively, a thermal link can be made between the onboard NTC and resistor R1, causing the board to turn off at an overtemperature of resistor R1.

The second option is to increase power factor is with a valley fill circuit. The basic schematic for this circuit is shown in <u>Figure 10</u>. <u>Table 3</u> shows the results when using a 10  $\mu$ F capacitor for C2X and C2Y.

Table 3. Power factor adjustment - valley fill circuit

| V <sub>i</sub> (V) | V <sub>o</sub> (V <sub>avr</sub> ) | I <sub>o</sub> (mA) | R1 (Ω) | η (%) | Power factor | THD (%) |
|--------------------|------------------------------------|---------------------|--------|-------|--------------|---------|
| 120                | 42.4                               | 133                 | 120    | 86.0  | 0.904        | 43.8    |
| 120                | 20.9                               | 137                 | 220    | 82.4  | 0.908        | 43.1    |



The valley fill circuit can only be employed in buck converter mode if the output voltage is below half the peak input voltage. In practice, at 120 V (AC) input it operates up to 50 V (DC) output voltage.

#### SSL21081 LED driver reference board

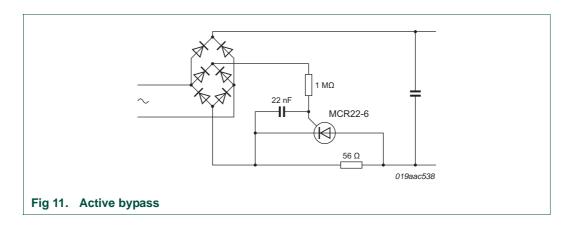
## 8. Active bypass

An increased value for the inrush current resistor protects the board from damage with most phase cut dimmers, but also lowers the efficiency. If a higher power factor is not required, but leading-edge dimmer resistance and high efficiency are important, the active bypass option is available. In this circuit, the inrush current resistor is bypassed using a Silicon Controlled Rectifier (SCR); see <u>Figure 11</u>.

Table 4 shows the results when active bypass is used.

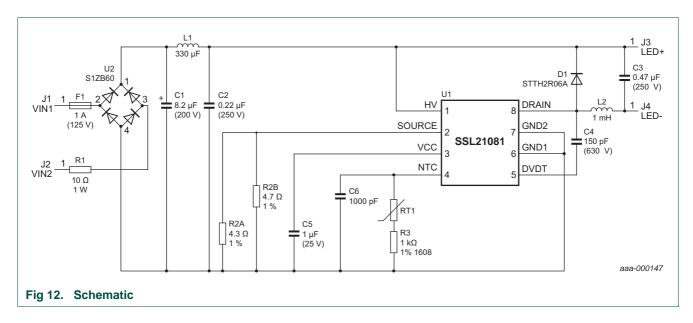
Table 4. Active bypass

| V <sub>i</sub> (V) | V <sub>o</sub> (V <sub>avr</sub> ) | I <sub>o</sub> (mA) | R1 (Ω) | η (%) | Power factor | THD (%) |
|--------------------|------------------------------------|---------------------|--------|-------|--------------|---------|
| 100                | 22                                 | 143                 | 56     | 86.2  | 0.566        | 135     |
| 100                | 43                                 | 130                 | 56     | 89.0  | 0.618        | 109     |
| 120                | 22                                 | 142                 | 56     | 85.0  | 0.533        | 151     |
| 120                | 43                                 | 130                 | 56     | 89.2  | 0.585        | 125     |



## SSL21081 LED driver reference board

## 9. Schematic



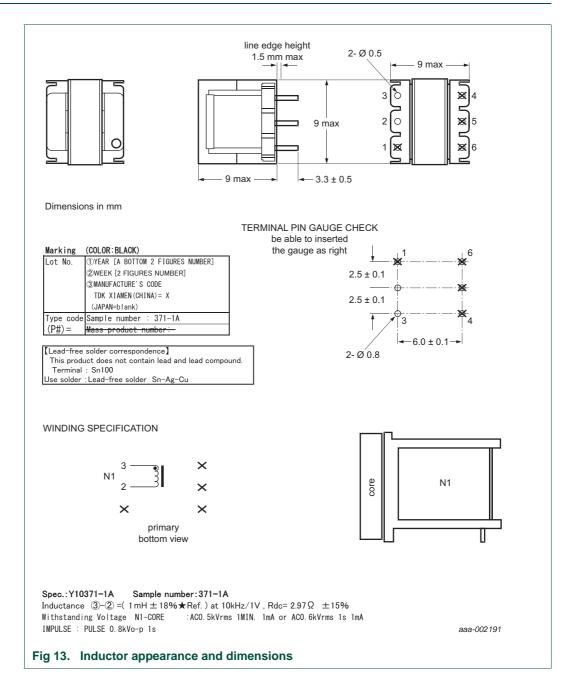
## 10. Bill of materials

Table 5. Bill of materials

| Part reference | Qty | Values                    | Manufacturer       | Part number        |
|----------------|-----|---------------------------|--------------------|--------------------|
| C1             | 1   | 8.2 μF; 200 V             | Rubycon            | 200BXC10M8X11.5    |
| C2             | 1   | 0.22 μF; X7R; 250 V       | Murata             | RDER72E224K8K1C11B |
| C3             | 1   | 0.47 μF; X7R; 250 V       | Murata             | RDER72E474K5B1C13B |
| C4             | 1   | 150 pF; C0G; 603 V        | Murata             | GRM31A5C2J151JW01D |
| C5             | 0   | 1 μF; F; 25 V             | Murata             | GRM188F51E105ZA12D |
| C6             | 1   | 1000 pF; X7R; 50 V        | Murata             | GRM188R71H102KA01D |
| D1             | 1   | 600 V; 1 A; fast recovery | ST Micro           | STTH2R06A          |
| F1             | 1   | 1 A; 125 V                | Littelfuse         | 473001             |
| L1             | 1   | 330 μΗ                    | Taiyo-Yuden        | CAL45VB331K        |
| L2             | 1   | 1 mH                      | TDK-EPC            | SRL8EE-201V001     |
| R1             | 1   | 10 Ω; 1 W                 | Panasonic          | ERG-1SJ100A        |
| R2A            | 1   | 3 Ω; 1 %; 2012            | Dale               | CRCW08053R00FKEA   |
| R2B            | 1   | 7.5 Ω; 1 %; 1608          | Dale               | CRCW06037R50FKEA   |
| R3             | 1   | 1 kΩ; 1 %; 1608           | Panasonic          | ERJ-3EKF1001V      |
| RT1            | 1   | 100 kΩ                    | Murata             | NXFT15WF104FA2B020 |
| U1             | 1   | SSL21081                  | NXP Semiconductors | SSL21081           |
| U2             | 1   | 600 V; 0.8 A              | Shindengen         | S1ZB60             |

#### SSL21081 LED driver reference board

## 11. Inductor appearance and dimensions



## SSL21081 LED driver reference board

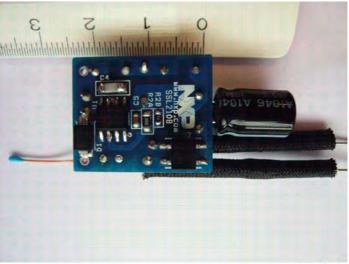
## 12. Printed-Circuit Board (PCB)

## 12.1 Board photographs



aaa-000150

a. Top view



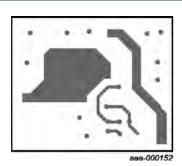
aaa-000151

b. Bottom view

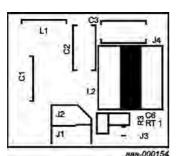
Fig 14. SSL21081 reference board photographs

## SSL21081 LED driver reference board

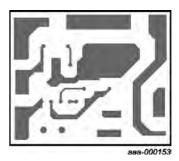
## 12.2 Board layouts



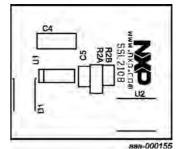
a. Top layer



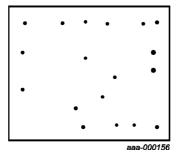
c. Top silk



b. Bottom layer



d. Bottom silk



e. Drill

Fig 15. Board layout

#### SSL21081 LED driver reference board

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#### 13.1 Definitions

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## SSL21081 LED driver reference board

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Date of release: 11 January 2012 Document identifier: UM10482